General Description

The MAX2871 is an ultra-wideband phase-locked loop (PLL) with integrated voltage control oscillators (VCOs) capable of operating in both integer-N and fractional-N modes. When combined with an external reference oscillator and loop filter, the MAX2871 is a high-performance frequency synthesizer capable of synthesizing frequencies from 23.5MHz to 6.0GHz while maintaining superior phase noise and spurious performance.

The ultra-wide frequency range is achieved with the help of multiple integrated VCOs covering 3000MHz to 6000MHz, and output dividers ranging from 1 to 128. The device also provides dual differential output drivers, which can be independently programmed to deliver -1dBm to +8dBm differential output power. Both outputs can be muted by either software or hardware control.

The MAX2871 is controlled by a 3-wire serial interface and is compatible with 1.8V control logic. The device is available in a lead-free, RoHS-compliant, 5mm x 5mm, 32-pin TQFN package, and operates over an extended -40°C to +85°C temperature range.

The MAX2871 has an improved feature set and better overall phase noise and is fully pin- and software- compatible with the MAX2870.

Applications

- Wireless Infrastructure
	- **Clock Generation Microwave Radios**

Test and Measurement

Benefits and Features

- Output Binary Buffers/Dividers Enable Extended Frequency Range
	- Divider Ratios of 1/2/4/8/16/32/64/128
	- 23.5MHz to 6000MHz
- High-Performance Phase Frequency Detector (PFD) and Reference Frequency Reduces Spectral Noise
	- PFD Up to 140MHz
	- Reference Frequency Up to 210MHz
- Low Normalized Inband Phase Noise of -230dBc/Hz Reduces System Noise Floor Contribution
- Manual or Automatic VCO Selection Permits Fast Switching
- Output Phase Reset and Adjustment Allow Synchronization of Multiple Synthesizers
- On-Chip Temperature Sensor with 7-Bit ADC Ensures Optimum VCO Selection
- Cycle Slip Reduction and Fast Lock Features Improve Accuracy and Acquisition Time
- VCO Lock Maintained Over Entire Temperature Range Provides Glitch-Free Operation
- Dual Differential Programmable Outputs Maximize Flexibility of Use

[Ordering Information](#page-26-0) and [Typical Application Circuit](#page-25-0) appears at end of data sheet.

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Thermal Characteristics (Note 1)

TQFN

Junction-to-Ambient Thermal Resistance (θJA)29°C/W Junction-to-Case Thermal Resistance (θJC)..............1.7°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maximintegrated.com/thermal-tutorial**.

DC Electrical Characteristics

(Measured using MAX2871 EV Kit. V_{CC} = 3V to 3.6V, V_{GND} = 0V, f_{REF_IN} = 50MHz, f_{PFD} = 50MHz, T_A = -40°C to +85°C. Typical values measured at V_{CC} = 3.3V; T_A = +25°C; register settings 00780000, 20000141, 01005E42, 00000013, 610F423C, 01400005;. unless otherwise noted.) (Note 2)

AC Electrical Characteristics

(Measured using MAX2871 EV Kit. V_{CC_} = 3V to 3.6V, V_{GND_} = 0V, f_{REF_IN} = 50MHz, f_{PFD} = 25MHz, f_{RFOUT_} = 6000MHz, ${\sf T}_{\sf A}$ = -40°C to +85°C. Typical values measured at V_{CC_} = 3.3V, T_A = +25°C, register settings 00780000, 20000141, 01005E42, 00000013, 610F423C, 01400005; unless otherwise noted.) (Note 2)

AC Electrical Characteristics (continued)

(Measured using MAX2871 EV Kit. V_{CC_} = 3V to 3.6V, V_{GND_} = 0V, f_{REF_IN} = 50MHz, f_{PFD} = 25MHz, f_{RFOUT_} = 6000MHz, ${\sf T}_{\sf A}$ = -40°C to +85°C. Typical values measured at V_{CC_} = 3.3V, T_A = +25°C, register settings 00780000, 20000141, 01005E42, 00000013, 610F423C, 01400005; unless otherwise noted.) (Note 2)

AC Electrical Characteristics (continued)

(Measured using MAX2871 EV Kit. V_{CC_} = 3V to 3.6V, V_{GND_} = 0V, f_{REF_IN} = 50MHz, f_{PFD} = 25MHz, f_{RFOUT_} = 6000MHz, ${\sf T}_{\sf A}$ = -40°C to +85°C. Typical values measured at V_{CC_} = 3.3V, T_A = +25°C, register settings 00780000, 20000141, 01005E42, 00000013, 610F423C, 01400005; unless otherwise noted.) (Note 2)

DIGITAL I/O CHARACTERISTICS

(V_{CC} = +3V to +3.6V, V_{GND} = 0V, T_A = -40°C to +85°C. Typical values at V_{CC} = 3.3V, T_A = +25°C.) (Note 2)

SPI TIMING CHARACTERISTICS

(V_{CC} = +3V to +3.6V, V_{GND} = 0V, T_A = -40°C to +85°C. Typical values at V_{CC} = 3.3V, T_A = +25°C.) (Note 2)

Note 2: Production tested at $T_A = +25^{\circ}$ C. Cold and hot are guaranteed by design and characterization.

Note 3: f_{REFIN} = 100MHz, phase detector frequency = 25MHz, RF output = 6000MHz.

Register setting: 00780000, 00400061, 34011242, F8010003, 638FF1FC, 80400005.

Note 4: Measured single ended with 27nH to V_{CC_RF} into 50Ω load. Power measured with single output enabled. Unused output has 27nH to V_{CC_RF} with 50Ω termination.

Note 5: VCO phase noise is measured open loop.

Note 6: Measured at 200kHz using a 50MHz Bliley NV108C19554 OCVCXO with 2MHz loop bandwidth. Register setting 801E0000, 8000FFF9, 80005FC2, 6C10000B, 638E80FC, 400005. EV kit loop filter: C2 = 1500pF, C1 = 33pF, R2A = 0Ω, R2B = 1100Ω, R3 = 0Ω, C3 = open.

Note 7: 1/f noise contribution to the in-band phase noise is computed by using 1/fnoise + 10log(10kHz/f_{OFFSET}) + 20log(f_{RF}/1GHz). Register setting: 803A0000, 8000FFF9, 81005F42, F4000013, 6384803C, 001500005.

Note 8: f_{RFFIN} = 50MHz; f_{PFD} = 25MHz; offset frequency = 10kHz; VCO frequency = 4227MHz, output divide-by-2 enabled. RFOUT = 2113.5MHz; N = 169; loop BW = 40kHz, CP[3:0] = 1111; integer mode.

Note 9: fREFIN = 50MHz; fPFD = 50MHz; VCO frequency = 4400MHz, fRFOUT_ = 4400MHz; loop BW = 65kHz. Register setting: 002C0000, 200303E9, 80005642, 00000133, 638E82FC, 01400005. EV kit loop filter: C2 = 0.1µF, C1 = 0.012µF, R2A = 0Ω, R2B = 120Ω, R3 = 250Ω, C3 = 820pF.

Typical Operating Characteristics

(Measured with MAX2871 EV Kit. V_{CC} = 3.3V, V_{GND} = 0V, f_{REF} = 50MHz, T_A = +25°C, see the [Testing Conditions](#page-7-0) Table.)

2113.5MHz FRACTIONAL-N PHASE NOISE vs. FREQUENCY (LOW-NOISE MODE)

⁹⁰⁴MHz INTEGER-N MODE PHASE NOISE AND SPUR PERFORMANCE vs. FREQUENCY

2687.5MHz INTEGER-N MODE PHASE NOISE AND SPUR PERFORMANCE vs. FREQUENCY

Typical Operating Characteristics (continued)

(Measured with MAX2871 EV Kit. V_{CC} = 3.3V, V_{GND} = 0V, f_{REF} = 50MHz, T_A = +25°C, see the [Testing Conditions](#page-7-0) Table.)

toc11

00 01 10 11

PWR SETTING

10 100 1k 10k

FREQUENCY (MHz)

50

toc17

SUPPLY CURRENT vs. FREQUENCY (TWO CHANNELS ACTIVE, MAXIMUM OUTPUT POWER) 300 tottiit 280 TA = +25˚C Ш $TA = +85^{\circ}C$ 260 $TA = -40^{\circ}C$ Ш $\widehat{\epsilon}$ 240 SUPPLY CURRENT (mA) Ш \mathbb{I} 220 SUPPLY CURRENT 11 I II Ш 200 180 160 Ш 140 \blacksquare 120 Ш 100 10 100 1K 10K

FREQUENCY (MHz)

PLL LOCK vs. TIME

3.85

60

Typical Operating Characteristics Testing Conditions Table

Typical Operating Characteristics Testing Conditions Table (continued)

Typical Operating Characteristics Testing Conditions Table (continued)

Pin Configuration

Pin Description

Pin Description (continued)

Detailed Description

4-Wire Serial Interface

The MAX2871 serial interface contains six write-only and one read-only 32-bit registers. The 29 most-significant bits (MSBs) are data, and the three least-significant bits (LSBs) are the register address. Register data is loaded MSB first through the 4-wire serial interface (SPI). When LE is logic-low, the logic level at DATA is shifted at the rising edge of CLK. At the rising edge of LE, the 29 data bits are latched into the register selected by the address bits. The user must program all register values after power-up.

Register programming order should be address 0x05, 0x04, 0x03, 0x02, 0x01, and 0x00. Several bits are double buffered to update the settings at the same time. See the register descriptions for double buffered settings.

MAX2871 23.5MHz to 6000MHz Fractional/ Integer-N Synthesizer/VCO

Register 0x06 can be read back through the MUX pin. The user must set MUX (register 5, bit 18 and register 2, bits $28:26$) = 1100. To begin the read sequence, set LE to logic-low, send 32 periods of CLK, and set LE to logic-high. While the CLK is running, the DATA pin can be held at logic-high or logic-low for 29 clocks, but the last 3 bits must be 110 to indicate register 6, then set LE back to logic-high after the 32nd clock. Finally, send 1 period of the clock. The MSB of register 0x06 appears on the falling edge of the next clock and continues to shift out for the next 29 clock cycles [\(Figure 2\)](#page-12-1). After the LSB of register 0x06 has been read, the user can reset MUX register = 0000.

Power Modes

The MAX2871 can be put into low-power mode by setting SHDN = 1 (register 2, bit 5) or by setting the CE pin to logic-low.

Figure 1. SPI Timing Diagram

Figure 2. Initiating Readback

Figure 3. Reference Input

After exiting low-power mode, allow at least 20ms for external capacitors to charge to their final values before programming the final VCO frequency.

Reference Input

The reference input stage is configured as a CMOS inverter with shunt resistance from input to output. In shutdown mode this input is set to high impedance to prevent loading of the reference source.

The reference input signal path also includes optional x2 and ÷2 blocks. When the reference doubler is enabled (DBR = 1), the maximum reference input frequency is limited to 105MHz. When the doubler is disabled, the reference input frequency is limited to 210MHz. The minimum reference frequency is 10MHz. The minimum R counter divide ratio is 1, and the maximum divide ratio is 1023.

Int, Frac, Mod and R Counter Relationship

The phase-detector frequency is determined as follows:

 $f_{\text{PFD}} = f_{\text{REF}} \times [(1 + \text{DBR}) / (\text{R} \times (1 + \text{RDIV2}))]$

f_{RFF} represents the external reference input frequency. DBR (register 2, bit 25) sets the f_{REF} input frequency doubler mode (0 or 1). RDIV2 (register 2, bit 24) sets the fREF divide-by-2 mode (0 or 1). R (register 2, bits 23:14) is the value of the 10-bit programmable reference counter (1 to 1023). The maximum f p_{FD} is 125MHz for frac-N mode and 140MHz for int-N mode. The R-divider can be held in reset when RST (register 2, bit 3) = 1.

The VCO frequency (f VCO), N, F, and M can be determined based on desired RF output frequency (f_{RFOLITA}) as follows:

Set DIVA value property based on fRFOUTA and [Table 4](#page-18-0) (register 4, bits 22:20)

 f_{VCO} = f_{RFOUTA} x DIVA

If bit $FB = 1$, (DIVA is not in PLL feedback loop):

$$
N + (F/M) = f_{VCO}/f_{\text{PFD}}
$$

If bit FB = 0, (DIVA is in PLL feedback loop) and DIVA \leq 16:

$$
N + (F/M) = (f_{VCO}/f_{\text{PFD}})/DIVA
$$

If bit $FB = 0$, (DIVA is in PLL feedback loop) and DIVA > 16 :

$N + (F/M) = (f_{VCO}/f_{\rm PFD})/16$

N is the value of the 16-bit N counter (16 to 65535), programmable through bits 30:15 of register 0. M is the fractional modulus value (2 to 4095), programmable through bits 14:3 of register 1. F is the fractional division value (0 to MOD - 1), programmable through bits 14:3 of register 0. In frac-N mode, the minimum N value is 19 and maximum N value is 4091. The N counter is held in reset when RST = 1 (register 2, bit 3). DIVA is the RF output divider setting (0 to 7), programmable through bits 22:20 of register 4. The division ratio is set by 2DIVA.

The RF B output frequency is determined as follows:

If BDIV = 0 (register 4, bit 9),
$$
f_{\text{RFOUTB}} = f_{\text{RFOUTA}}
$$
.
If BDIV = 1, $f_{\text{RFOUTB}} = f_{\text{VCO}}$.

Int-N/Frac-N Modes

Integer-N mode is selected by setting bit INT = 1 (register 0, bit 31). When operating in integer-N mode, it is also necessary to set bit LDF (register 2, bit 8) to set the lock detect to integer-N mode.

The device's frac-N mode is selected by setting bit $INT = 0$ (register 0, bit 31). Additionally, set bit LDF = 0 (register 2, bit 8) for frac-N lock-detect mode.

If the device is in frac-N mode, it will remain in frac-N mode when fractional division value $F = 0$, which can result in unwanted spurs. To avoid this condition, the device can automatically switch to integer-N mode when $F = 0$ if the bit F01 = 1 (register 5, bit 24).

Phase Detector and Charge Pump

The device's charge-pump current is determined by the value of the resistor from pin RSET to ground and the value of bits CP (register 2, bits 12:9) as follows:

$$
ICP = 1.63/R_{SET} \times (1 + CP < 3.0)
$$

To reduce spurious in frac-N mode, set charge-pump linearity bits CPL = 00/01/10/11 (register 1, bits 30:29). The user can determine which mode works best for their application. For int-N mode, set CPL = 00.

The charge-pump output can be put into high-impedance mode when $TRI = 1$ (register 2, bit 4). The output is in normal mode when TRI = 0.

The phase detector polarity can be changed if an active inverting loop filter topology is used. For noninverting loop filters, set PDP = 1 (register 2, bit 6). For inverting loop filters, set $PDP = 0$.

MUX

MUX is a multipurpose input/output for observing and controlling various internal functions of the MAX2871. MUX can also be configured as serial data output. Bits MUX (register 5, bit 18 and register 2, bit 28:26) are used to select the desired MUX function (see [Table 5](#page-19-0)).

Lock Detect

Lock detect can be monitored through the LD output by setting the LD bits (register 5, bits 23:22). For digital lock detect, set $LD = 01$. The digital lock detect is dependent on the mode of the synthesizer. In frac-N mode set LDF = 0, and in int-N mode set $LDF = 1$. To set the accuracy of the digital lock detect, see [Table 1](#page-14-0) and [Table 2](#page-14-1).

Analog lock detect can be set with $LD = 10$. In this mode, LD is an open-drain output and requires an external pullup resistor.

The lock detect output validity is dependent on many factors. The lock detect output is not valid during VCO auto selection process. After the VCO auto selection process has completed, the lock detect output is not valid until the TUNE voltage has settled. TUNE voltage settling time is dependent on loop filter bandwidth, and can be calculated using EE-Sim Simulation tool found at **www.maximintegrated.com**.

Table 1. Frac-N Digital Lock-Detect Settings

PFD FREQUENCY LDS LDP LOCKED UP/DOWN TIME SKEW (ns) NUMBER OF LOCKED CYCLES TO SET LD UP/DOWNTIME SKEW TO UNSET LD (ns) ≤ 32MHz 0 0 10 40 15 ≤ 32MHz 0 1 6 40 15

> 32MHz | 1 | X | 4 4 40 | 4

Table 2. Int-N Digital Lock-Detect Settings

Cycle Slip Reduction

Cycle slip reduction is one of the two methods available to improve lock time. It is enabled by setting CSM bit (register 3, bit 18) to 1. In this mode, the charge pump must be set to its minimum value.

Fast-Lock

Another method to decrease lock time is to use a fast-lock mode. This mode requires that CP = 0000 (register 2, bits 12:9) and that the shunt resistive portion of the loop filter be segmented into two parts, where one resistor is 1/4 of the total resistance, and the other resistor is 3/4 of the

Figure 4. Fast Lock Filter Topology

total resistance. The larger resistor should be connected from ground to SW, and the smaller resistor from SW to the loop filter capacitor (see [Figure 4](#page-14-2)). When CDM = 01 (register 3, bits 16:15), fast-lock is active after the VAS has completed. During fast-lock, the charge pump is increased to CP = 1111 and the shunt loop filter resistance is set to 1/4 of the total resistance by changing pin SW from high impedance to ground. Fast-lock deactivates after a timeout set by the user. This timeout is loop filter dependent, and is set by:

$t_{FAST-LOCK}$ = M x CDIV/f $_{\text{PFD}}$

where M is the modulus setting and CDIV is the clock divider setting. The user must determine the CDIV setting based on their loop filter time constant.

RFOUTA± and RFOUTB±

The device has dual differential open-collector RF outputs that require an external RF choke or a 50Ω resistor to supply for each output. Each differential output can be independently enabled or disabled by setting bits RFA_EN (register 4, bit 5) and RFB_EN (register 4, bit 8). Both outputs are also controlled by applying a logic-high (enabled) or logic-low (disabled) to pin RFOUT_EN.

The output power of each output can be individually controlled with APWR (register 4, bits 4:3) for RFOUTA and BPWR (register 4, bits 7:6) for RFOUTB. The available differential output power settings are from -4dBm to +5dBm, in 3dB steps with 50 Ω pullup to supply. The available single-ended output power ranges from -4dBm to +5dBm in 3dB steps with a RF choke to supply. Across the entire frequency range different pullup elements (L or R) are required for optimal output power. If single-ended output is used, the unused output should be supplied and terminated in the same manner as the corresponding load. If a differential output is unused then those RFOUT pins should be directly connected to VCC_RF (pin 16).

To prevent undesired frequencies from being output while acquiring lock, the output power can be disabled when the PLL is unlocked by using MTLD (register 4, bit 10). A logic 1 will disable the outputs when the digital lock detect is logic low. When acquiring lock the output can overshoot and pass through the desired frequency. In some circumstances, the digital lock detect will flicker high during these periods. To prevent this from happening, a timer can be used to delay the output from enabling after losing lock. Enable MUTEDEL (register 3, bit 17) with MTLD enabled to use this function. The delay for enabling the output is set by:

Delay = CDIV \times M/f_{PFD}

where CDIV (register 3, bits 14:3) is the clock divider, M (register 1, bits 14:3) is the variable modulus for the fractional N modulator, and f_{PFD} is the phase detector frequency.

Voltage-Controlled Oscillator

The fundamental VCO frequency of the device guarantees gap-free coverage from 3.0GHz to 6.0GHz using four individual VCO core blocks with 16 sub-bands within each block. Connect the output of the loop filter to the TUNE input. The TUNE input is used to control the VCO.

Tune ADC

A 7-bit ADC is used to read back the VCO tuning voltage. The ADC value can be read back through register 6, bits 22:16. To digitize the tuning voltage, do the following:

- 1) Set bits CDIV (register 3, bits $14:3$) = f $p_{F,D}/100$ kHz to set the clock speed for the ADC.
- 2) Set bits ADCM (register 5, bits 5:3) = 100 to enable the ADC to read the TUNE pin voltage.
- 3) Set bit ADCS (register 5, bit 6) = 1 to start the ADC conversion process.
- 4) Wait 100µs for the conversion process to finalize.
- 5) Read back register 6. The ADC value is located in bits 22:16.
- 6) Reset bits $ADCM = 0$ and $ADCS = 0$.

The voltage on the TUNE pin can be calculated as:

 $V = 0.315 + ADC \times 0.0165$

VCO Autoselect (VAS) State Machine

An internal VCO autoselect state machine is initiated when register 0 is programmed to automatically select the correct VCO if bit VAS $SHDN = 0$ (register 3, bit 25). If VAS_SHDN = 1, then the VCO can be manually selected by bits VCO (register 3, bits 31:26).

The state machine clock, f_{BS} , must be set to 50kHz. This is set by the BS bits (register 4, bits 25:24, 19:12). The formula for setting BS is:

$BS = f_{\text{PFD}}/50kHz$

where f_{PFD} is the phase-detector frequency. The BS value should be rounded to the nearest integer. If the calculated BS is higher than 1023, then set BS = 1023. If f_{PFD} is lower than 50kHz, then set BS = 1. The time needed to select the correct VCO is $10/f_{BS}$.

The VAS TEMP bit (register 3, bit 24) can be used to select the best VCO for the given ambient temperature to ensure that the VCO will not drift out of lock if the tem-

perature changes within -40°C to +85°C. Bits RFA_EN (register 4, bit 5) and RFB_EN (register 4, bit 8) must be 0, and bits 30:29 of register 5 must be set to 11 during VCO acquisition. Setting VAS_TEMP = 1 will increase the time needed to achieve lock from $10/f_{BS}$ to approximately 100ms.

Phase Adjustment

After achieving lock, the phase of the RF output can be changed in increments of P (register 1, bits 26:15) /M (register 1, bits 14:3) x 360°.

For proper phase adjustment, the following register guidelines must be used:

- \bullet INT (register 0, bit 31) = 0
- N (register 0, bits $30:15$) ≤ 19 and ≥ 4091
- FBMUX (register 4, bit 23) = 0
- BDIV (register 4, bit 9) = 0
- DIVA (register 4, bits 22:20) \leq 100 (less than or equal to divide-by-16, which limits the minimum output frequency to 187.5MHz)
- SDN (register 2, bits $30:29$) = 00
- F01 (register 5, bit 24) = 0
- DBR (register 2, bit 25) = 0
- RDIV2 (register 2, bit 24)= 0
- It is recommended to set R (register 2, bits $23:14$) = 1. For other R divider values, please contact Maxim Technical Support.

When aligning the phase of multiple devices, connect their MUX and REF_IN pins together and do the following:

- 1) Force the voltage on the MUX pin to V_{II} .
- 2) Set MUX register bits = 0111.
- 3) Program the MAX2871s for the desired frequency and allow them to lock.
- 4) Force the voltage on the MUX pins to V_{IH} . This resets the MAX2871s so they are synchronous. The MUX sync pulse rising edge cannot occur inside setup/hold time window around the reference signal rising edge:

 t SETUP = $(4/N)$ x t PFD + 2.6ns $t_{\text{HOLD}} = (4/N) \times t_{\text{PFD}}$

where N is the MAX2871's N counter ratio (register 0, bits 30:15) and $tpFD = 1/fpFD$

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- 5) Optional: To use the MUX pin for other functions (i.e. register readback) in conjunction with phase synchronization, follow the steps below:
	- Force the voltage on the MUX pins back to V_{IL}
	- Set MUX register = 0000 (Hi-Z mode)
	- Remove the forced voltage from the MUX pin
	- The MUX pin is now ready for other functions
- 6) Set P (register 1, bits 26:15) for the desired amount of phase shift for each part.
- 7) Set CDM (register 3, bits 16:15) = 10.
- 8) Reset CDM = 00.

Low-Spur Mode

The device offers three modes for the sigma-delta modulator. Low-noise mode offers lower in-band noise at the expense of spurs. The spurs can be reduced by setting $SDN = 10$ (register 2, bits 30:29) or $SDN = 11$ for different modes of dithering. The user can determine which mode works best for their application.

Temperature Sensor

The device is equipped with an on-chip temperature sensor and 7-bit ADC.

To read the digitized output of the temperature sensor:

- 1) Set bits CDIV (register 3, bits $14:3$) = f $p_{FD}/100$ kHz to set the clock speed for the ADC.
- 2) Set bits ADCM (register 5, bits 5:3) = 001 to enable the ADC to read the temperature.
- 3) Set bit ADCS (register 5, bit 6) = 1 to start the ADC conversion process.
- 4) Wait 100µs for the conversion process to finalize.
- 5) Read back register 6. The ADC value is located in bits 22:16.
- 6) Reset bits ADCM=0 and ADCS=0.

The approximate ambient temperature can be converted as:

$t = 95 - 1.14$ x ADC

This formula is most accurate when the VCO is enabled and RFOUTA is enabled at full output power. The temperature can vary based on output power and if one or both outputs are enabled.

Register and Bit Descriptions

The operating mode of the device is controlled by five onchip registers.

Defaults are not guaranteed upon power-up and are provided for reference only. All reserved bits should only be written with default values. In low-power mode, the register values are retained. Upon power-up, the registers should be programmed twice with at least a 20ms pause between writes. The first write ensures that the device is enabled, and the second write starts the VCO selection process.

Table 3. Register 0 (Address: 000, Default: 007D0000_{HEX})

Table 4. Register 1 (Address: 001, Default: 2000FFF9 $_{\text{Hex}}$)

Table 5. Register 2 (Address: 010, Default: 00004042_{HEX})

Table 5. Register 2 (Address: 010, Default: 00004042_{HEX}) (continued)

Table 6. Register 3 (Address: 011, Default: 0000000B_{HEX})

Table 7. Register 4 (Address: 100, Default: 6180B23C_{HEX})

Table 7. Register 4 (Address: 100, Default: 6180B23C_{HEX}) (continued)

Table 8. Register 5 (Address: 101, Default: 00400005_{HEX})

Table 9. Register 6 (Read-Only Register)

Typical Application Circuit

Ordering Information

+Denotes lead(Pb)-free/RoHS-compliant package.

**EP = Exposed pad.*

Package Information

For the latest package outline information and land patterns (footprints), go to **www.maximintegrated.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Revision History

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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